



## Surface Mount Trench MOS Barrier Schottky Rectifier



### FEATURES

- Low profile package
- Ideal for automated placement
- Trench MOS Schottky technology
- Low power losses, high efficiency
- Low forward voltage drop
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Compliant to RoHS directive 2002/95/EC and in accordance to WEEE 2002/96/EC



**RoHS**  
COMPLIANT

### TYPICAL APPLICATIONS

For use in low voltage, high frequency inverters, freewheeling, dc-to-dc converters, and polarity protection applications.

### MECHANICAL DATA

**Case:** DO-214AA (SMB)

Molding compound meets UL 94 V-0 flammability rating  
Base P/N-E3 - RoHS compliant, commercial grade

**Terminals:** Matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

E3 suffix meets JESD 201 class 1A whisker test

**Polarity:** Color band denotes the cathode end

PRIMARY CHARACTERISTICS	
$I_{F(AV)}$	3.0 A
$V_{RRM}$	100 V
$I_{FSM}$	80 A
$E_{AS}$	50 mJ
$V_F$ at $I_F = 3.0$ A	0.56 V
$T_J$ max.	150 °C

MAXIMUM RATINGS ( $T_A = 25$ °C unless otherwise noted)			
PARAMETER	SYMBOL	VSSB310	UNIT
Device marking code		V3B	
Maximum repetitive peak reverse voltage	$V_{RRM}$	100	V
Maximum DC forward current	$I_F^{(1)}$	3.0	A
	$I_F^{(2)}$	1.9	
Peak forward surge current 10 ms single half sine-wave superimposed on rated load	$I_{FSM}$	80	A
Non-repetitive avalanche energy at $T_J = 25$ °C, $L = 60$ mH	$E_{AS}$	50	mJ
Peak repetitive reverse current at $t_p = 2$ $\mu$ s, 1 kHz, $T_J = 38$ °C $\pm$ 2 °C	$I_{RRM}$	1.0	A
Operating junction and storage temperature range	$T_J, T_{STG}$	- 40 to + 150	°C

#### Notes

(1) Mounted on 10 mm x 10 mm pad areas, 1 oz. FR4 P.C.B.

(2) Free air, mounted on recommended copper pad area

ELECTRICAL CHARACTERISTICS (T <sub>A</sub> = 25 °C unless otherwise noted)						
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT
Breakdown voltage	I <sub>R</sub> = 1.0 mA	T <sub>A</sub> = 25 °C	V <sub>BR</sub>	100 (minimum)	-	V
Instantaneous forward voltage	I <sub>F</sub> = 3.0 A	T <sub>A</sub> = 25 °C	V <sub>F</sub> <sup>(1)</sup>	0.62	0.70	V
		T <sub>A</sub> = 125 °C		0.56	0.65	
Reverse current	V <sub>R</sub> = 70 V	T <sub>A</sub> = 25 °C	I <sub>R</sub> <sup>(2)</sup>	1.5	-	μA
		T <sub>A</sub> = 125 °C		1.2	-	mA
	V <sub>R</sub> = 100 V	T <sub>A</sub> = 25 °C		7.0	250	μA
		T <sub>A</sub> = 125 °C		3.6	20	mA
Typical junction capacitance	4.0 V, 1 MHz		C <sub>J</sub>	230	-	pF

Notes

- (1) Pulse test: 300 μs pulse width, 1 % duty cycle
- (2) Pulse test: Pulse width ≤ 40 ms

THERMAL CHARACTERISTICS (T <sub>A</sub> = 25 °C unless otherwise noted)			
PARAMETER	SYMBOL	VSSB310	UNIT
Typical thermal resistance	R <sub>θJA</sub> <sup>(1)</sup>	120	°C/W
	R <sub>θJM</sub> <sup>(2)</sup>	15	

Notes

- (1) Free air, mounted on recommended P.C.B. 1 oz. pad area. Thermal resistance R<sub>θJA</sub> - junction to ambient
- (2) Units mounted on P.C.B. with 10 mm x 10 mm copper pad areas. R<sub>θJM</sub> - junction to mount

ORDERING INFORMATION (Example)				
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE
VSSB310-E3/52T	0.096	52T	750	7" diameter plastic tape and reel
VSSB310-E3/5BT	0.096	5BT	3200	13" diameter plastic tape and reel

RATINGS AND CHARACTERISTICS CURVES

(T<sub>A</sub> = 25 °C unless otherwise noted)

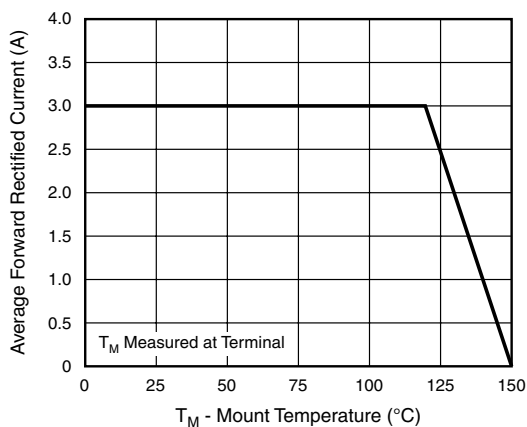


Fig. 1 - Maximum Forward Current Derating Curve

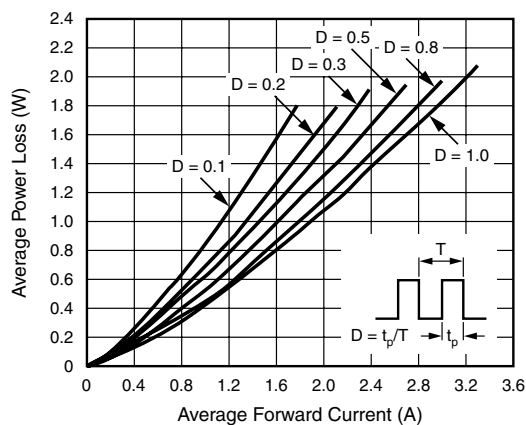


Fig. 2 - Forward Power Loss Characteristics

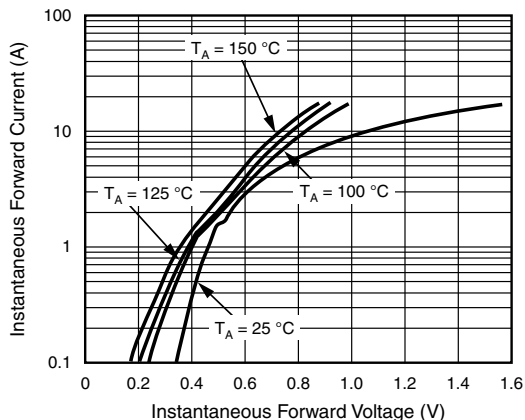


Fig. 3 - Typical Instantaneous Forward Characteristics

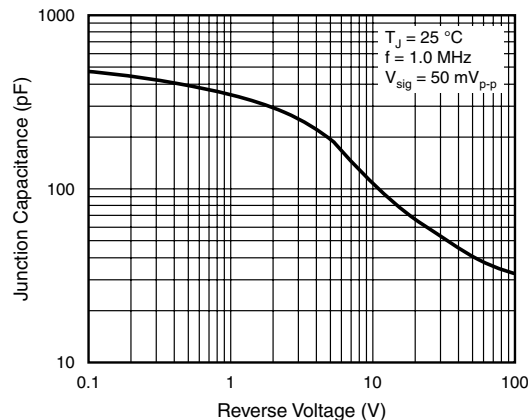


Fig. 5 - Typical Junction Capacitance

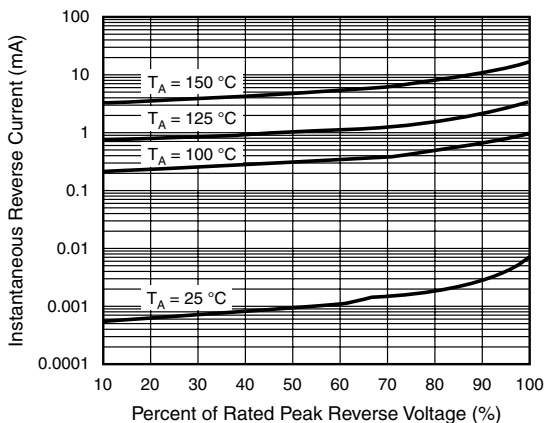


Fig. 4 - Typical Reverse Characteristics

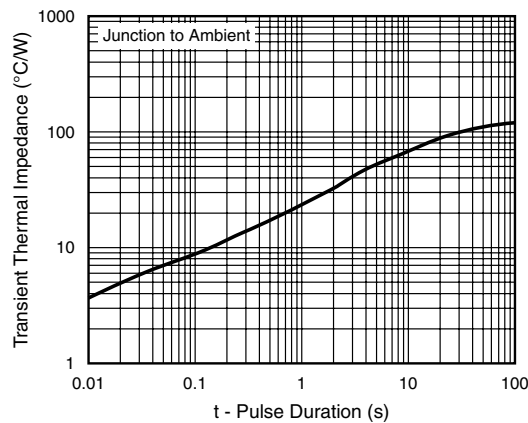
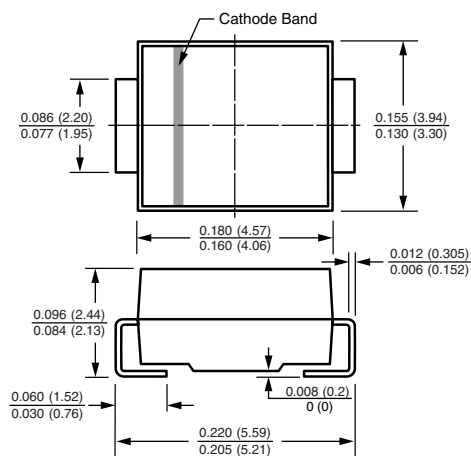


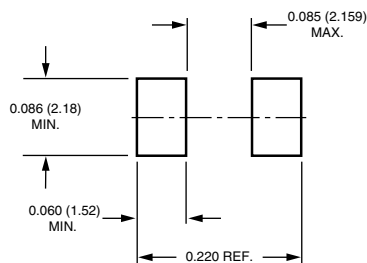
Fig. 6 - Typical Transient Thermal Impedance

**PACKAGE OUTLINE DIMENSIONS** in inches (millimeters)

**DO-214AA (SMB)**



**Mounting Pad Layout**





## Disclaimer

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